

# BFN19

## **PNP Silicon High-Voltage Transistors**

- Suitable for video output stages in TV sets and switching power supplies
- High breakdown voltage
- Low collector-emitter saturation voltage
- Complementary types: BFN18 (NPN)
- Pb-free (RoHS compliant) package
- Qualified according AEC Q101



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Туре	Marking	Pin Configuration			Package
BFN19	DH	1=B	2=C	3=E	SOT89

#### **Maximum Ratings**

Parameter	Symbol	Value	Unit	
Collector-emitter voltage	V <sub>CEO</sub>	300	V	
Collector-base voltage	V <sub>CBO</sub>	300		
Emitter-base voltage	V <sub>EBO</sub>	5		
Collector current	I <sub>C</sub>	200	mA	
Peak collector current, $t_p \le 10 \text{ ms}$	/ <sub>CM</sub>	500		
Base current	I <sub>B</sub>	100		
Peak base current	/ <sub>BM</sub>	200		
Total power dissipation-	P <sub>tot</sub>	1	W	
<i>T</i> <sub>S</sub> ≤ 130 °C				
Junction temperature	Ti	150	°C	
Storage temperature	T <sub>stg</sub>	-65 150		
Thermal Resistance				

Parameter	Symbol	Value	Unit
Junction - soldering point <sup>1)</sup>	R <sub>thJS</sub>	≤ 20	K/W

<sup>1</sup>For calculation of  $R_{\text{thJA}}$  please refer to Application Note AN077 (Thermal Resistance Calculation)



Parameter	Symbol		Values	1	Unit
		min.	typ.	max.	
DC Characteristics			1	1	· · · · ·
Collector-emitter breakdown voltage	V <sub>(BR)CEO</sub>	300	-	-	V
$I_{\rm C}$ = 1 mA, $I_{\rm B}$ = 0					
Collector-base breakdown voltage	V <sub>(BR)CBO</sub>	300	-	-	
<i>I</i> <sub>C</sub> = 100 μA, <i>I</i> <sub>E</sub> = 0					
Emitter-base breakdown voltage	V <sub>(BR)EBO</sub>	5	-	-	
/ <sub>E</sub> = 100 μA, / <sub>C</sub> = 0					
Collector-base cutoff current	I <sub>CBO</sub>				μA
$V_{\rm CB}$ = 250 V, $I_{\rm E}$ = 0		-	-	0.1	
$V_{\rm CB}$ = 250 V, $I_{\rm E}$ = 0 , $T_{\rm A}$ = 150 °C		-	-	20	
Emitter-base cutoff current	I <sub>EBO</sub>	-	-	100	nA
$V_{\rm EB}$ = 5 V, $I_{\rm C}$ = 0					
DC current gain <sup>1)</sup>	h <sub>FE</sub>				-
<i>I</i> <sub>C</sub> = 1 mA, <i>V</i> <sub>CE</sub> = 10 V		25	-	-	
<i>I</i> <sub>C</sub> = 10 mA, <i>V</i> <sub>CE</sub> = 10 V		40	-	-	
<i>I</i> <sub>C</sub> = 30 mA, <i>V</i> <sub>CE</sub> = 10 V		30	-	-	
Collector-emitter saturation voltage <sup>1)</sup>	V <sub>CEsat</sub>	-	-	0.5	V
<i>I</i> <sub>C</sub> = 20 mA, <i>I</i> <sub>B</sub> = 2 mA					
Base emitter saturation voltage <sup>1)</sup>	V <sub>BEsat</sub>	-	-	0.9	
<i>I</i> <sub>C</sub> = 20 mA, <i>I</i> <sub>B</sub> = 2 mA					
AC Characteristics			·	· · · ·	
Transition frequency	f <sub>T</sub>	-	100	-	MHz
$I_{\rm C}$ = 20 MHz, $V_{\rm CE}$ = 10 V, $f$ = 20 MHz					
Collector-base capacitance	C <sub>cb</sub>	-	2.5	-	pF
			1	1	1

**Electrical Characteristics** at  $T_A = 25^{\circ}$ C, unless otherwise specified

<sup>1</sup>Pulse test: t < 300 $\mu$ s; D < 2%

 $V_{\rm CB}$  = 30 V, f = 1 MHz



**DC** current gain  $h_{\text{FE}} = f(I_{\text{C}})$ 

*V*<sub>CE</sub> = 10 V





HP00589

**Operating range**  $I_{\rm C} = f(V_{\rm CEO})$ 

 $T_{\rm A} = 25^{\circ}{\rm C}, D = 0$ 



**Collector cutoff current**  $I_{CBO} = f(T_A)$ 

 $V_{\rm CBO}$  = 200 V





**Transition frequency**  $f_{\rm T} = f(I_{\rm C})$ 

*V*<sub>CE</sub> = 10 V



Total power dissipation  $P_{tot} = f(T_S)$ 



Collector-base capacitance  $C_{cb} = f(V_{CB})$ Emitter-base capacitance  $C_{eb} = f(V_{EB})$ 



# Permissible Pulse Load

 $P_{\text{totmax}}/P_{\text{totDC}} = f(t_p)$ 









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